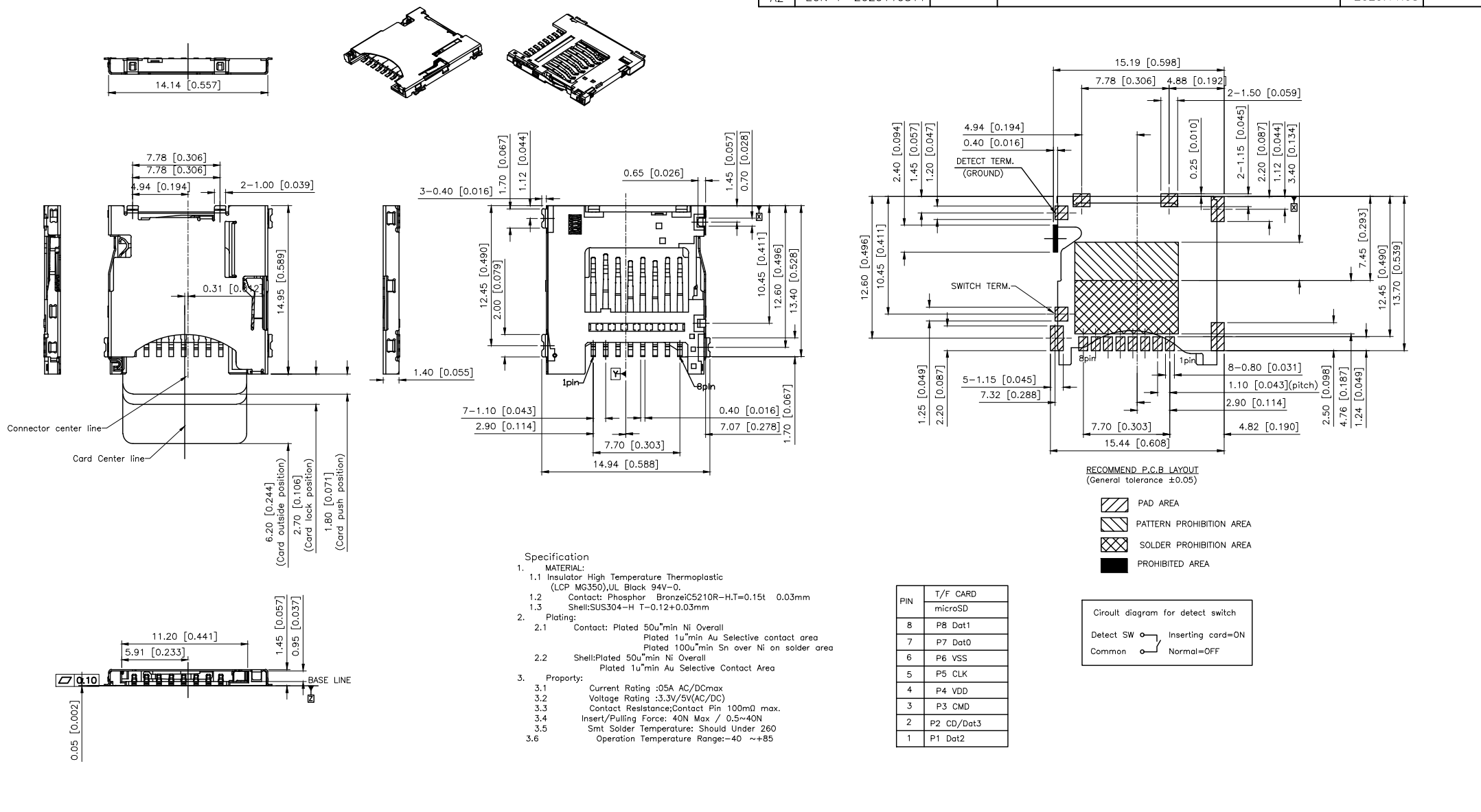
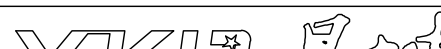


REVISIONS				
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE
A1	N/A			2025.05.16
A2	ECN-P-2025110811			2025.11.08



- Specification
- MATERIAL:
 - Insulator High Temperature Thermoplastic (LCP MG350),UL Black 94V-0.
 - Contact: Phosphor Bronze/C5210R-H,T=0.15t 0.03mm
 - Shell:SUS304-H T=0.12+0.03mm
 - Plating:
 - Contact: Plated 50u"min Ni Overall
Plated 1u"min Au Selective contact area
Plated 100u"min Sn over Ni on solder area
 - Shell:Plated 50u"min Ni Overall
Plated 1u"min Au Selective Contact Area
 - Property:
 - Current Rating :05A AC/DCmax
 - Voltage Rating :3.3V/5V(AC/DC)
 - Contact Resistance:Contact Pin 100mΩ max.
 - Insert/Pulling Force: 40N Max / 0.5~40N
 - Smt Solder Temperature: Should Under 260
 - Operation Temperature Range:-40 ~+85

AuGLAR	±5°		DESIGN		VIEW: 	MODEL TYPE: TF CARD CONN		
X.	±0.40		CHECKED		UNIT: mm/in	PART NO.: XKTF-1251-1		
X.x	±0.30		APPROVED		SIZE: A4	DWG NO.:		
X.xx	±0.20							
X.xxx	±0.15							
UNSPECIFIED TOLERANCES						SCALE		
www.xk-dg.cn		XKB INDUSTRIAL PRECISION CO.,LIMITED				N/A		
						PAGE		
						1/1		
						REVISION		
						A2		